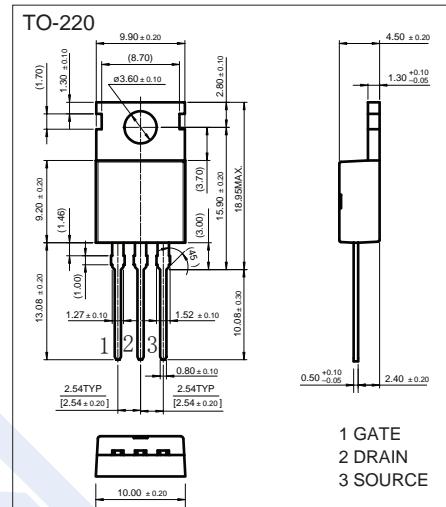


## P-Channel MOSFET

2KJ6069

## ■ Features

- $V_{DS}$  (V) = -60V
  - $I_D$  = -80 A
  - $R_{DS(ON)} < 19.5m\Omega$  @  $V_{GS} = -10V$
  - $R_{DS(ON)} < 21.5m\Omega$  @  $V_{GS} = -4.5V$



#### ■ Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	-60	V
Gate-Source Voltage	V <sub>GС</sub>	±20	
Continuous Drain Current <sup>*1</sup>	I <sub>D</sub>	-80	A
Pulsed Drain Current <sup>*2</sup>	I <sub>DM</sub>	-200	
Single Pulse Avalanche Energy <sup>*3</sup>	E <sub>AS</sub>	196	mJ
Power Dissipation <sup>*1</sup>	P <sub>D</sub>	75	W
Thermal Resistance, Junction- to-Ambient <sup>*4</sup>	R <sub>θJA</sub>	100	°C/W
Thermal Resistance, Junction- to-Case <sup>*1</sup>	R <sub>θJC</sub>	1.66	
Junction Temperature	T <sub>J</sub>	150	°C
Junction Storage Temperature Range	T <sub>stg</sub>	-55 to 150	

Notes: 1.  $T_c=25^\circ\text{C}$  Limited only by maximum temperature allowed.

2.  $P_w \leq 10\mu s$ , Duty cycle  $\leq 1\%$ .

3. EAS condition:  $V_{DD} = -15V$ ,  $V_{GS} = -10V$ ,  $L = 0.5mH$ ,  $R_g = 25\Omega$  Starting  $T_J = 25^\circ C$ .

4. The value of  $R_{eJA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25^\circ\text{C}$ .

## P-Channel MOSFET

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■ Electrical Characteristics ( $T_a = 25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Off characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{Id}=-250\mu\text{A}, \text{V}_{\text{GS}}=0\text{V}$	-60			V
Zero Gate Voltage Drain Current	$\text{Id}_{\text{SS}}$	$\text{V}_{\text{DS}}=-48\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{T}_j=25^\circ\text{C}$		-1		$\mu\text{A}$
		$\text{V}_{\text{DS}}=-48\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{T}_j=125^\circ\text{C}$		-100		
Gate-Body Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{DS}}=0\text{V}, \text{V}_{\text{GS}}=\pm20\text{V}$		$\pm100$		nA
<b>On characteristics</b> <sup>5</sup>						
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{Id}=-250\mu\text{A}$	-1.1		-2.1	V
Static Drain-Source On-Resistance	$\text{R}_{\text{DS(on)}}$	$\text{V}_{\text{GS}}=-10\text{V}, \text{Id}=-20\text{A}$			19.5	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-4.5\text{V}, \text{Id}=-20\text{A}$			21.5	$\text{m}\Omega$
<b>Dynamic characteristics</b> <sup>5,6</sup>						
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=-25\text{V}, \text{f}=1\text{MHz}$		4500		pF
Output Capacitance	$\text{C}_{\text{oss}}$			705		
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$			515		
Gate resistance	$\text{R}_g$	$\text{f}=1\text{MHz}$		5.7		$\Omega$
<b>Switching characteristics</b> <sup>5,6</sup>						
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{GS}}=-10\text{V}, \text{V}_{\text{DS}}=-30\text{V}, \text{Id}=-20\text{A}$		72		nC
Gate Source Charge	$\text{Q}_{\text{gs}}$			15		
Gate Drain Charge	$\text{Q}_{\text{gd}}$			17		
Turn-On Delay Time	$\text{t}_{\text{d(on)}}$	$\text{V}_{\text{DD}}=-30\text{V}, \text{R}_g=3\Omega, \text{R}_L=1.5\Omega, \text{V}_{\text{GS}}=-10\text{V}$		16		ns
Turn-On Rise Time	$\text{t}_r$			18		
Turn-Off Delay Time	$\text{t}_{\text{d(off)}}$			39		
Turn-Off Fall Time	$\text{t}_f$			44		
<b>Drain-Source Diode Characteristics</b> <sup>5</sup>						
Maximum Body-Diode Continuous Current	$\text{I}_{\text{s}}$				-80	A
Maximum Body-Diode Pulsed Current	$\text{I}_{\text{SM}}$				-200	
Diode Forward Voltage	$\text{V}_{\text{SD}}$	$\text{I}_{\text{s}} = -20\text{A}, \text{V}_{\text{GS}}=0\text{V}$			-1.2	V

Notes: 5. Pulse Test : Pulse Width  $\leqslant 300\mu\text{s}$ , duty cycle  $\leqslant 2\%$ .

6. Guaranteed by design, not subject to production.

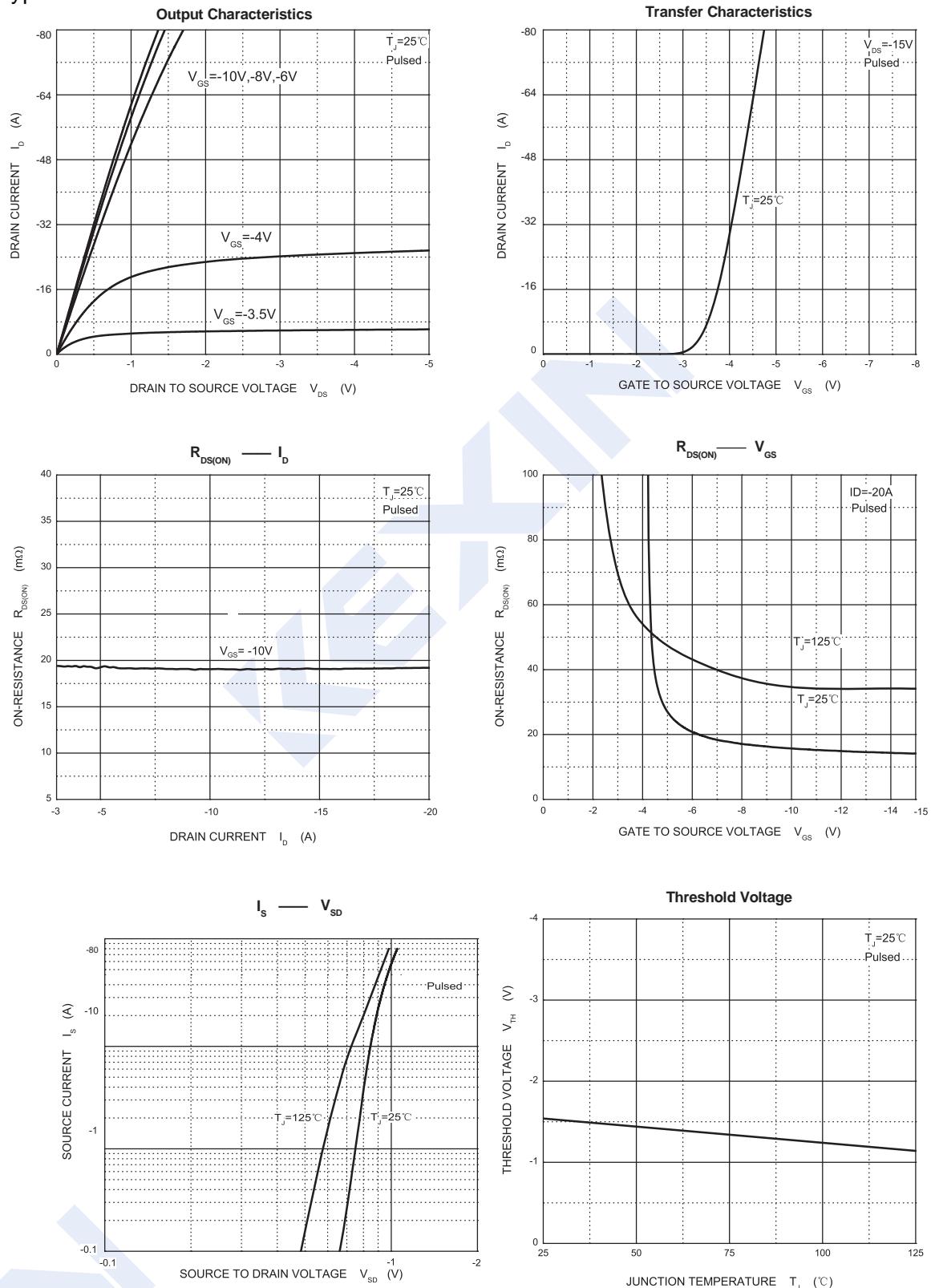
## ■ Marking

2KJ6069	J6069 K***
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## P-Channel MOSFET

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## ■ Typical Characteristics



## P-Channel MOSFET

2KJ6069

